UNITED STATES SECURITIES AND EXCHANGE COMMISSION

Washington, D.C. 20549

FORM 8-K

CURRENT REPORT Pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934

Date of Report (Date of earliest event reported): November 15, 2011

TTM TECHNOLOGIES, INC.

(Exact name of registrant as specified in its charter)

DELAWARE	E 0-31285 91-1033443			
(State or other Jurisdiction of Incorporation)	(Commission File Number)	(IRS Employer Identification No.)		
2630 SOUTH HARBOR BOUI	LEVARD			
SANTA ANA, CALIFOR	NIA	92704		
(Address of Principal Executive	Offices)	(Zip Code)		
	s telephone number, including area code: (7	<u></u>		
(Former	name or former address if changed since ia	st report.)		
Check the appropriate box below if the Form any of the following provisions:	8-K filing is intended to simultaneously sat	isfy the filing obligation of the registrant under		
☐ Written communications pursuant to Rule	425 under the Securities Act (17 CFR 230.	125)		
☐ Soliciting material pursuant to Rule 14a-1	2 under the Exchange Act (17 CFR 240.14a	-12)		
☐ Pre-commencement communications purs	uant to Rule 14d-2(b) under the Exchange A	Act (17 CFR 240.14d-2(b))		
☐ Pre-commencement communications purs	uant to Rule 13e-4(c) under the Exchange A	act (17 CFR 240.13e-4(c))		

Item 7.01. Regulation FD Disclosure.

We are filing this Current Report on Form 8-K in connection with the disclosure of textual information from a slide show presentation given at the UBS Global Technology and Services Conference on November 15, 2011. A copy of this slide show presentation is being furnished as Exhibit 99.1 to this Current Report on Form 8-K.

The information in this Current Report (including the exhibit) is furnished pursuant to Item 7.01 and shall not be deemed to be "filed" for the purpose of Section 18 of the Securities Exchange Act of 1934, as amended, or otherwise subject to the liabilities of that section. This Current Report will not be deemed an admission as to the materiality of any information in this Current Report that is required to be disclosed solely by Regulation FD.

We do not have, and expressly disclaim, any obligation to release publicly any updates or any changes in our expectations or any change in events, conditions, or circumstances on which any forward-looking statement is based.

The information included with this Current Report (including the exhibit) will be available at our website located at www.ttmtech.com, although we reserve the right to discontinue that availability at any time.

The information in this Report includes references to "Adjusted EBITDA." Adjusted EBITDA is defined as earnings before interest expense, income taxes, depreciation, amortization and asset impairment. We present adjusted EBITDA to enhance the understanding of our operating results. Adjusted EBITDA is a key measure we use to evaluate our operations. In addition, we provide our adjusted EBITDA because we believe that investors and securities analysts will find adjusted EBITDA to be a useful measure for evaluating our operating performance and comparing our operating performance with that of similar companies that have different capital structures and for evaluating our ability to meet our future debt service, capital expenditures and working capital requirements. However, adjusted EBITDA should not be considered as an alternative to cash flows from operating activities as a measure of liquidity or as an alternative to net income as a measure of operating results in accordance with accounting principles generally accepted in the United States of America.

Item 9.01. Financial Statements and Exhibits.

(d) Exhibits.

99.1 Slides presented at the UBS Global Technology and Services Conference on November 15, 2011.

SIGNATURE

Pursuant to the requirements of the Securities I	Exchange Act of 1934,	the registrant has duly	caused this report to	be signed on its behalf
by the undersigned hereunto duly authorized.				

 $TTM\ TECHNOLOGIES, INC.$

Date: November 15, 2011

By: /s/ Steven W. Richards Steven W. Richards Chief Financial Officer

TTM Technologies Investor Presentation



Global Presence Local Knowledge

UBS Global Technology and Services Conference
November 15, 2011

Safe Harbor

During the course of this presentation, the company will make forward-looking statements subject to known and unknown risks and uncertainties that could cause actual results to differ materially from those expressed or implied by such statements. Such risks and uncertainties include, but are not limited to, fluctuations in quarterly and annual operating results, the volatility and cyclicality of various industries that the company serves and other risks described in TTM's most recent SEC filings. The company assumes no obligation to update the information provided in this presentation.

The company also will present non-GAAP financial information in this presentation. For a reconciliation of TTM's non-GAAP financial information to the equivalent measures under GAAP, please refer to the company's press release, which was filed with the SEC and which is posted on TTM's website.



Company Overview



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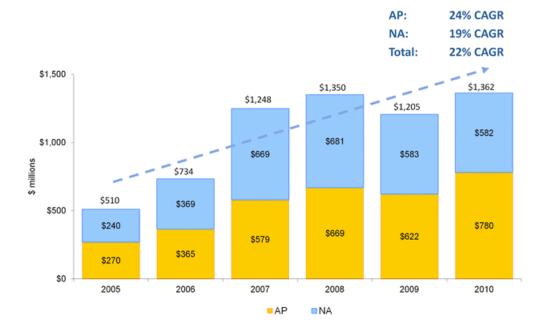
Global Leader in PCB Manufacturing

- Top 5 global PCB manufacturer \$1.4 billion in revenue*
- 15 specialized factories located in U.S. and China
- Over 17,000 employees worldwide
- Focused on advanced technology products
- Total customer solution: prototype through production
- Technology development coordinated with customers' needs
- Diversified end markets with broad customer base

* Pro forma 2010

TTM Technologies 4

Historical Pro Forma Sales

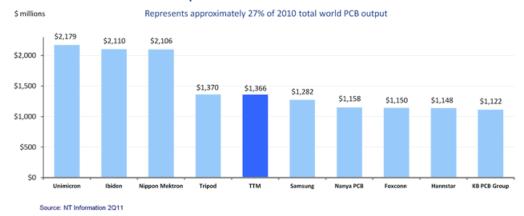


TTM Technologies

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Current Global Ranking

Top 10 World PCB Makers 2010

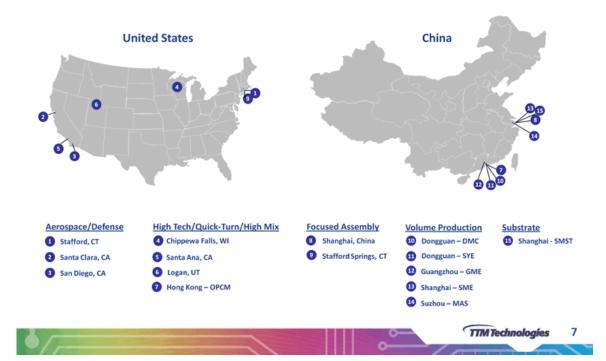


Leading Position in Growing Market Segments

- Core supplier to wide range of high-end networking products addressing increasing bandwidth demands
- Key supplier in rapidly growing touch screen tablet market
- Expanding position in smartphones
- Leadership position in strategic North America Aerospace & Defense industry

Specialized Facilities Provide Optimal Growth

Integrated manufacturing platform enables TTM to execute a global facility specialization strategy



Global Strength

North America

Asia Pacific

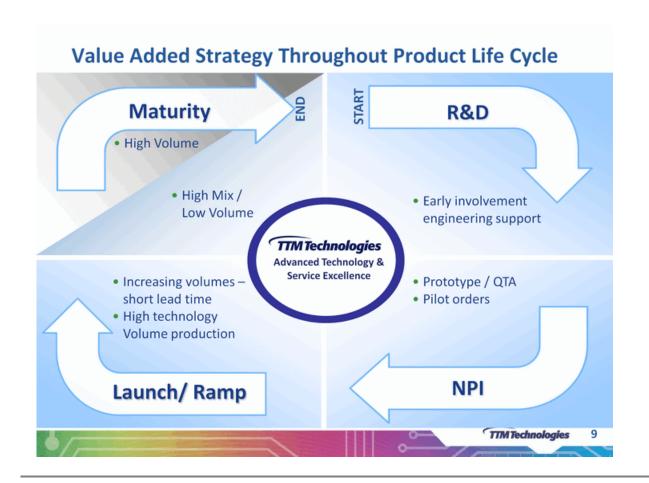
- 7 factories
- Aerospace & Defense, High End Servers, Storage and Networking
- Proto, Ramp and Low Volume/ High Mix production
- Highest average layer count in North America
- Specialty rigid-flex, RF and thermal management PCBs
- Advanced HDI for commercial and defense

- 8 factories
- Smartphones, Tablet PCs, Servers,
 Storage and Networking
- Advanced "any layer" HDI
- High layer count conventional PCB
 - Flex & rigid-flex PCB
 - Substrate PCB

Combined Strength, Total Solution

TTM Technologies

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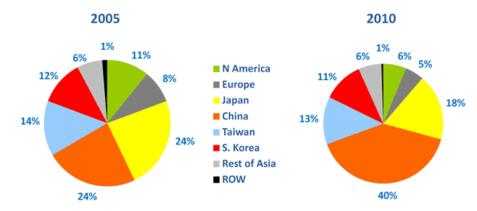


Industry & Market Overview



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Historical PCB Production by Region



\$ millions

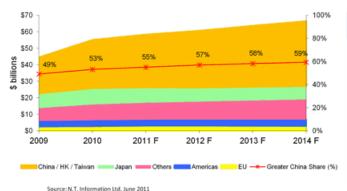
Year/Region	N. America	Europe	Japan	China	Taiwan	S. Korea	Rest of Asia	ROW	Total
2005	4,583	3,605	9,995	10,060	5,980	4,890	2,750	539	42,402
2010	3,330	2,801	9,895	22,185	7,076	6,087	3,437	271	55,082
% change	-27%	-22%	-1%	121%	18%	24%	25%	-50%	30%

Expectations are for continued growth in China

Source: N.T. Information Ltd. September 2007, June 2011



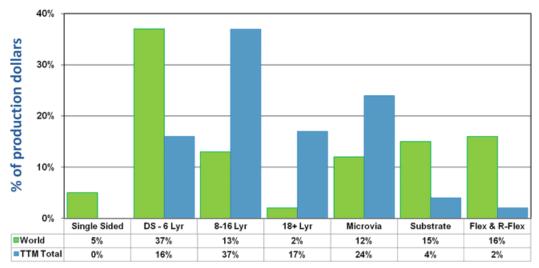
World PCB Outlook



Region	2009 \$ B	2014 \$B	09 /14 CAGR
China / HK / Taiwan	\$29.3	\$39.4	12.5%
Japan	\$8.9	\$8.0	-2.2%
SE Asia, Korea, Others	\$8.0	\$12.4	9.2%
Americas	\$3.2	\$3.8	3.3%
EU	\$2.5	\$2.9	2.7%

- The worldwide PCB market grew 24% in 2010 following the global slowdown in 2008-2009
- 59% of world PCB production will be generated from the Greater China region in 2014
- PCB production in the Americas is expected to deliver moderate growth and remains significant to TTM

2010 World PCB Production by Product Type

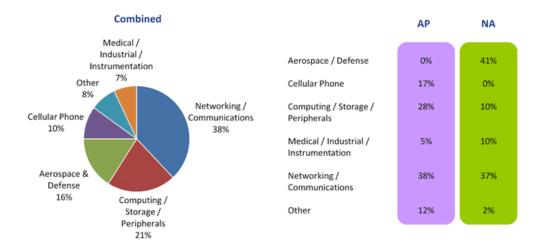


Source: Prismark Partners, August 2011

TTM is focused on advanced technology



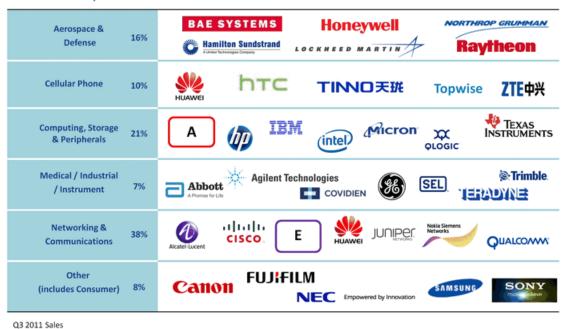
Diversified End Markets



Q3 2011 Sales

Diversified End Market & Customer Base

Selected Customers by End Market



Future Plans & Strategies

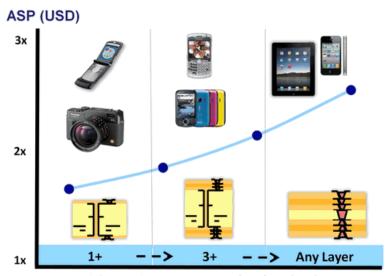


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Positioned for Revolutionary Growth



Technology & ASP



High Density Interconnect (HDI) Technology

Key Initiatives

AP - Growth Strategy

- Focus on smartphone, touch-pad tablets and other hand-held devices by expanding further in advanced HDI flex and rigid-flex
- Continue to grow higher conventional technology capabilities for networking infrastructure
- Leverage niche position in substrate
- Grow organically

NA - Growth Strategy

- Continued focus in advanced technology, HMLV and QTA
- Expand HDI capacity for North America requirements
- Leverage A&D market leadership
- Grow business by servicing customers globally
- Manage balance sheet for growth and risk

Financial Overview



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Adjusted Income Statement – Q3 YTD Actual*

\$ millions (except where noted)	Asia Pacific*	North America	Total*
Revenue	\$645.3	\$421.9	\$1,067.2
Gross Profit	145.1 22.5%	84.8 20.1%	229.9 21.5%
Operating Income	80.5 12.5%	41.1 9.7%	121.6 11.4%
TTM Net Income	54.8 8.5%	22.5 5.3%	77.3 7.2%
GAAP Diluted EPS \$ per share	0.67	0.27	0.94
Non-GAAP EPS S per diluted share	0.81	0.38	1.19
EBITDA	135.1 20.9%	54.9 13.0%	190.0 17.8%

^{*} Excludes \$48.1 million impairment charge

Target Model

			2011		
(\$ in millions, except EPS)	Q1	Q2*	Q3	Q4 Est.	Target Model
Revenue	\$342.8	\$366.1	\$358.3	\$345 - \$365	10% - 12% Annual Growth
Gross Profit	\$81.9	\$77.3	\$70.7	\$67 - \$76	
Gross Margin	23.9%	21.1%	19.7%	19% - 21%	23%
Operating Income	\$45.7	\$39.6	\$36.3	\$28 - \$37	
Operating Margin	13.3%	10.8%	10.1%	8% - 10%	13%
GAAP Diluted EPS	\$0.33	\$0.31	\$0.30	\$0.19 - \$0.28	
Non-GAAP Diluted EPS	\$0.40	\$0.40	\$0.38	\$0.27 - \$0.36	
Operating Cash Flow	\$37.1	\$67.8	\$42.5		
Free Cash Flow	\$10.6	\$23.7	\$14.3		

^{*} Excludes \$48.1 million impairment charge

Balance Sheet Highlights

(\$ in millions)	December 31, 2010	September 26, 2011
Assets		
Cash and Cash Equivalents	\$216.1	\$207.7
Accounts and Notes Receivable, Net	287.7	301.2
Inventories	135.4	147.6
Property, Plant and Equipment, Net	740.6	755.3
Goodwill	197.8	197.6
Definite-Lived Intangibles, Net	97.9	84.7
All Other Assets	86.5	84.2
Total Assets	\$1,762.0	\$1,778.3
Liabilities and Equity		
ST Debt, Including Current Portion of LT Debt	67.1	120.8
Accounts Payable, Including Due to Related Parties	205.0	216.0
Convertible Senior Notes, Net	145.3	149.6
Long-Term Debt, Less Current Portion	313.0	217.1
All Other Liabilities	198.7	173.4
Total Liabilities	929.1	876.9
Total Equity	832.9	901.4
Total Liabilities and Equity	\$1,762.0	\$1,778.3

Cash Flow

(\$ in millions)	2010	YTD 9/26/2011
Net Income	\$79.9	\$34.9
Depreciation of Property, Plant and Equipment	48.7	49.7
Amortization of Definite-Lived Intangible Assets	13.8	12.9
Deferred Income Taxes	16.4	10.8
Stock-Based Compensation	6.9	5.9
Impairment of Long-Lived Assets	0.8	48.1
Other Operating Activities	7.5	5.2
Working Capital Changes	(48.2)	(20.1)
Cash Flow from Operations	125.8	147.4
Net Capital Expenditures	(59.9)	(98.9)
Other Investing Activities	92.9	0.1
Cash Flow from Investing Activities	33.0	(98.8)
Repayment of Borrowings, Net of Proceeds	(38.0)	(42.7)
Other Financing Activities	2.6	(12.3)
Cash Flow from Financing Activities	(35.4)	(55.0)
Free Cash Flow	\$65.9	\$48.5

Investment Highlights

- Market leader in advanced technology PCBs globally
- Strong track record of operating performance
- Emphasis on customer service with facilities tailored to meet customer needs now and in the future
- Focused on growth through organic opportunities as well as strategic acquisitions
- · Healthy balance sheet and solid cash flow funding growth



Appendix



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Working Capital Efficiency

	2009	2010	1Q11	2Q11	3Q11
A/R Days	63.2	72.1	73.6	72.9	75.7
Inventory Days	49.1	46.2	46.7	45.0	45.7
A/P Days	49.5	89.1	93.5	88. 9	91.0
Cash Conversion Cycle	62.8	29.2	26.8	29.0	30.4

Reconciliations

		YTD
(\$ in millions, except EPS)	2010	9/26/2011
Adjusted EBITDA Reconciliation:		
Net Income	\$79.9	\$34.9
Add Back Items:		
Income Tax Provision	28.7	24.7
Interest Expense	22.3	19.7
Depreciation Expense	48.7	49.7
Amortization of Intangibles	13.8	12.9
EBITDA	\$193.4	\$141.9
Add Back: Impairment of Long-lived Assets	\$0.7	\$48.1
Adjusted EBITDA	\$194.1	\$190.0
Non-GAAP EPS Reconciliation:		
Net Income Attributable to Stockholders	\$71.5	\$30.7
Add Back Items:	47.110	400
Amortization of Intangibles	13.8	12.9
Stock-Based Compensation	6.9	5.9
Non-Cash Interest Expense	7.7	6.2
Impairment, Restructuring and Other Charges	17.8	48.1
Income Tax Effects	(12.2)	(6.7)
Non-GAAP net income attributable to stockholders	\$105.5	\$97.1
Non-GAAP earnings per diluted share attributable to stockholders	\$1.49	\$1.19
Diluted Shares	70,819	81,929

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